



RECOMMENDED PCB BOARD LAYOUT  
(TOL. ±0.05)(TOP VIEW)

REV	ECN NO	OR DESCRIPTION	REVISED	DATE
A		PRODUCT RELEASE	JUN H04	10/26/07

- NOTE:
- MATERIAL:  
HOUSING:HIGH TEMP. THERMAL PLASTIC,UL 94V-0,COLOR BLACK.  
TERMINAL: COPPER ALLOY,T=0.20mm;  
FROK:COPPER ALLOY,T=0.20mm.
  - FINISH:  
TERMINAL:15u" MIN GOLD PLATING ON CONTACT AREA;  
1u" MIN GOLD PLATING ON OTHER AREAS;  
60u" MIN NICKEL UNDERPLATING OVERALL.

- 3.SPECIFICATION:SEE 2.5mm BATTERY 3H PRODUCT SPEC.
4. SOLDER HEAT RESISTANCE: REFLOW SOLDERING 260° FOR 10SEC.
5. TO CONFORM TO THE "SE-01-001" & "ROHS DIRECTIVE".
6. GREEN PRODUCT IDENTIFICATION MARK IN JACK: **G.P. PASS**
7. GREEN PRODUCT IDENTIFICATION IN PACKING: **G.P. PASS**
8. FOR REFLOW SOLDERING LEED FREE PROCESS.
9. ALL DIMENSIONS MUST BE INSPECTED BY GA,EXCEPT REF DIMENSIONS.
10. DATE CODE DESCRIPTION:"YYMMDD"

△1 P/N DESCRIPTION:  
2BA2000-011511

DAY  
MONTH  
YEAR

PACKAGE: TAPE AND REEL  
HOUSING COLOR: BLACK  
TERMINAL FINISH GOLD 15u" ON CONTACT AREA

NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
C	FROK	1	COPPER ALLOY,0.2T	SEE NOTE
B	TERMINAL	4	COPPER ALLOY,0.2T	SEE NOTE
A	HOUSING	1	HIGH TEMP. THERMAL PLASTIC UL 94V-0	COLOR BLACK

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS: ANGLES:

X :±0.5 X :±2  
XX :±0.3 X.X :±1°  
X.XX :±0.2

TITLE: 2.5mm BATTERY 4PIN 3H SMT TYPE  
DWN JUN H04 10/26/07 PART NO.:2BA2000-011511  
CHKD ZKCHN 10/26/07 SCALE:1/1 UNIT: mm  
APVD SEAN 10/26/07 SIZE: A3 SHEET:1 OF 1 REV: A

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